

Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)
 Contact Info: ti.com/support
 Form/Declaration Type: Distribute - RoHS and IEC 62474 DB
 Created on: 06/04/2022

Details for "OPA2837IRUNR"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
OPA2837IRUNR	NIPDAU	Level-2-260C-1 YEAR	TI Semiconductor	RUN 10	2x2x0.75	11.8

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

Component	Substance	CAS Number	Amount (mg)	Homogeneous Material Level		Component Level	
				Percentage %	ppm	Percentage %	ppm
Bond Wire							
Precious Metals	Gold	7440-57-5	0.053387	99.998127	999981	0.451313	4513
Precious Metals	Silver	7440-22-4	0.000001	0.001873	19	0.000008	0
Sub-Total			0.053388	100	1000000	0.451321	4513
Die Attach Adhesive							
Other Inorganic Materials	Aluminum Oxide	1344-28-1	0.028296	30	300000	0.239203	2392
Other Inorganic Materials	Silica	7631-86-9	0.004244	4.499576	44996	0.035877	359
Thermoplastics	Epoxy	85954-11-6	0.06178	65.500424	655004	0.522264	5223
Sub-Total			0.09432	100	1000000	0.797344	7973
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	6.959027	97.519997	975200	58.828885	588289
Copper and Its Alloys	Iron	7439-89-6	0.164128	2.3	23000	1.387474	13875
Copper and Its Alloys	Phosphorus	7723-14-0	0.002141	0.030003	300	0.018099	181
Zinc and Its Alloys	Zinc	7440-66-6	0.010704	0.15	1500	0.090487	905
Sub-Total			7.136	100	1000000	60.324945	603249
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.207362	95.120183	951202	1.752957	17530
Precious Metals	Gold	7440-57-5	0.0017	0.779817	7798	0.014371	144
Precious Metals	Palladium	7440-05-3	0.008938	4.1	41000	0.075558	756
Sub-Total			0.218	100	1000000	1.842886	18429
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	3.305115	88.000012	880000	27.940146	279401
Other Organic Materials	Chlorine	7782-50-5	0.000038	0.001012	10	0.000321	3
Other Plastics and Rubber	Carbon Black	1333-86-4	0.011267	0.299988	3000	0.095247	952
Thermoplastics	Epoxy	85954-11-6	0.439392	11.698988	116990	3.714448	37144
Sub-Total			3.755812	100	1000000	31.750161	317502
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	0.571749	100	1000000	4.833342	48333
Sub-Total			0.571749	100	1000000	4.833342	48333
Total			11.829269			100	1000000

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.
 The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component.
[See Glossary of Terms for more details.](#)

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSI or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

[For an explanation of the methods used to determine material weights, See Product Content Methodology.](#)

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

[For additional information, please contact TI customer support.](#)

Signature: [\(click here for a fuller statement with a signed certificate\)](#)

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 For further environmental statements, please go to www.ti.com/ecoinfo
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RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in <http://www.ti.com/lit/pdf/szzq088>

Green: Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb2O3) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.